

FEATURES

- Single Chip Provides Complete LocalTalk®/AppleTalk® Port
- Low Power: $I_{CC} = 1.2\text{mA}$ Typ
- Shutdown Pin Reduces I_{CC} to $30\mu\text{A}$ Typ
- Drivers Maintain High Impedance in Three-State or with Power Off
- 30ns Driver Propagation Delay Typ
- 5ns Driver Skew Typ
- Thermal Shutdown Protection
- Drivers are Short-Circuit Protected

APPLICATIONS

- LocalTalk Peripherals
- Notebook/Palmtop Computers
- Battery-Powered Systems

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DESCRIPTION

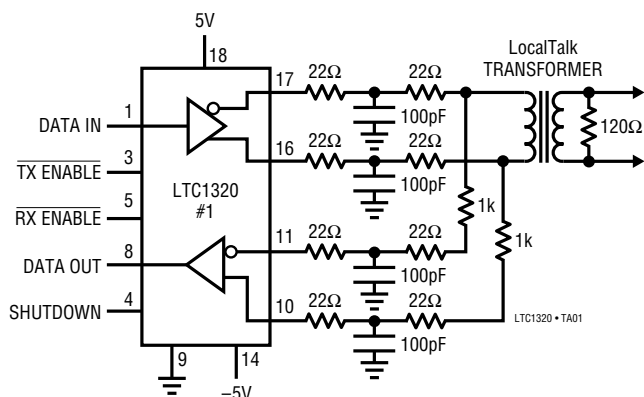
The LTC1320 is an RS422/RS562 line transceiver designed to operate on LocalTalk networks. It provides one differential RS422 driver, one single-ended RS562 driver, two single-ended RS562 receivers, and one differential RS422 receiver. The LTC1320 draws only 1.2mA quiescent current when active and $30\mu\text{A}$ in shutdown, making it ideal for use in battery-powered devices and other systems where power consumption is a primary concern.

The LTC1320 drivers are specified to drive $\pm 2\text{V}$ into 100Ω . Additionally, the driver outputs three-state when disabled, during shutdown, or when the power is off; they maintain high impedance even with output common-mode voltages beyond the power supply rails. Both the driver outputs and receiver inputs are protected against ESD damage to beyond 5kV.

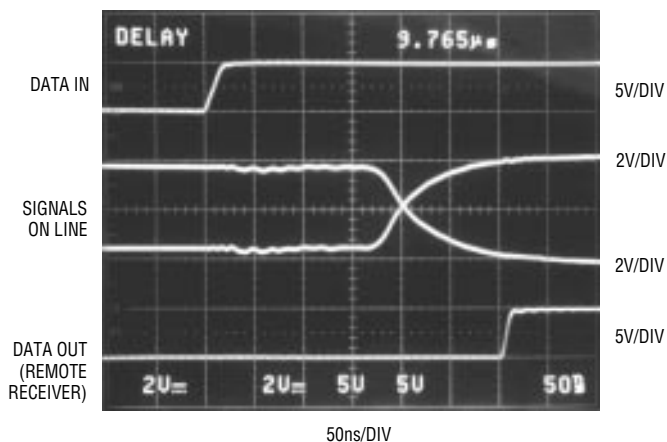
The LTC1320 is available in the 18-pin SOL package.

TYPICAL APPLICATION

Typical LocalTalk Connection



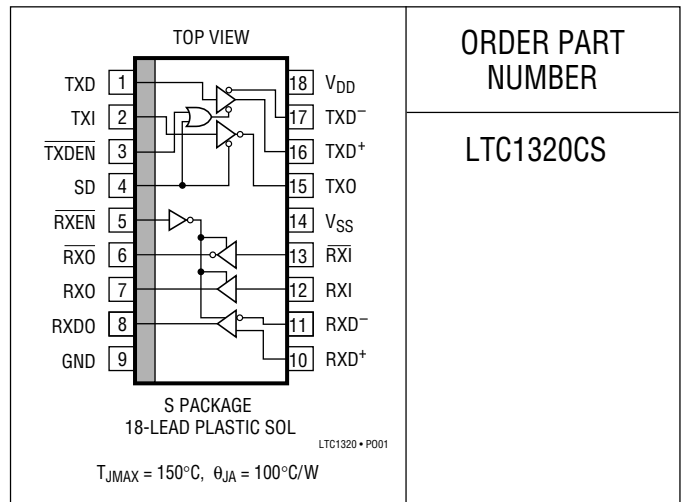
Output Waveforms



ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V_{DD})	7V
Supply Voltage (V_{SS})	-7V
Input Voltage (Logic Inputs)	-0.3V to $V_{DD} + 0.3V$
Input Voltage (Receiver Inputs)	$\pm 15V$
Driver Output Voltage (Forced)	$\pm 15V$
Output Short-Circuit Duration	Indefinite
Operating Temperature Range	0°C to 70°C
Storage Temperature Range	-65°C to 150°C
Lead Temperature (Soldering, 10 sec)	300°C

PACKAGE/ORDER INFORMATION

ORDER PART
NUMBER

LTC1320CS

Consult factory for Industrial and Military grade parts.

DC ELECTRICAL CHARACTERISTICS $V_S = \pm 5V \pm 5\%$, $T_A = 0^{\circ}C$ to $70^{\circ}C$ (Notes 2, 3)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V_{OD}	Differential Driver Output Voltage	No Load	● 8.0			V
		$R_L = 100\Omega$ (Figure 1)	● 2.0			V
		$R_L = 100\Omega$ (Figure 1)		0.2		V
V_{OC}	Driver Common-Mode Output Voltage	$R_L = 100\Omega$ (Figure 1)		3		V
		Output Common-Mode Range	●		± 10	V
		SD = 5V or Power Off	●			V
	Single-Ended Driver Output Voltage	No Load	● ± 4.0			V
		$R_L = 400\Omega$	● ± 3.4			V
	Input High Voltage	All Logic Input Pins	● 2.0			V
	Input Low Voltage	All Logic Input Pins	●		0.8	V
	Input Current	All Logic Input Pins	●	± 1	± 20	μA
	Three-State Output Current	SD = 5V or Power Off, $-10V < V_O < 10V$	●	± 2	± 100	μA
	Driver Short-Circuit Current	$-5V < V_O < 5V$	● 35	350	500	mA
	Receiver Input Resistance	$-7V < V_{IN} < 7V$	● 12			k Ω
V_{OH}	Receiver Output High Voltage	$I_O = -4mA$	● 3.5			V
V_{OL}	Receiver Output Low Voltage	$I_O = 4mA$	●		0.4	V
	Receiver Output Short-Circuit Current	$0V < V_O < 5V$	● 7		85	mA
	Receiver Output Three-State Current	$0V < V_O < 5V$	●	± 2	± 100	μA
	Differential Receiver Threshold Voltage	$-7V < V_{CM} < 7V$	● -200		200	mV
	Differential Receiver Input Hysteresis	$-7V < V_{CM} < 7V$		70		mV
	Single-Ended Receiver Input Low Voltage		●		0.8	V
	Single-Ended Receiver Input High Voltage		● 2			V
I_{DD}	Supply Current	No Load, SD = 0V	●	1.2	3.0	mA
		No Load, SD = 5V	●	30	350	μA
I_{SS}	Supply Current	No Load, SD = 5V	●	2	350	μA

SWITCHING CHARACTERISTICS $V_S = \pm 5V \pm 5\%$, $T_A = 0^\circ C$ to $70^\circ C$ (Notes 2, 3)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
$t_{PLH, HL}$	Differential Driver Propagation Delay	$R_L = 100\Omega$, $C_L = 100pF$ (Figures 2, 8)	●		40	120	ns
t_{SKEW}	Differential Driver Output to Output	$R_L = 100\Omega$, $C_L = 100pF$ (Figures 2, 8)	●		10	50	ns
$t_{r, f}$	Differential Driver Rise/Fall Time	$R_L = 100\Omega$, $C_L = 100pF$ (Figures 2, 8)	●		15	80	ns
$t_{ENH, L}$	Driver Enable to Output Active	$C_L = 100pF$ (Figures 3, 4, 10)	●		50	150	ns
$t_{H, Ldis}$	Driver Output Active to Disable	$C_L = 15pF$ (Figures 3, 4, 10)	●		50	150	ns
$t_{PLH, HL}$	Single-Ended Driver Propagation Delay	$R_L = 450\Omega$, $C_L = 100pF$ (Figures 5, 11)	●		40	120	ns
$t_{r, f}$	Single-Ended Driver Rise/Fall Time	$R_L = 450\Omega$, $C_L = 100pF$ (Figures 5, 12)	●		15	80	ns
$t_{PLH, HL}$	Receiver Propagation Delay	$C_L = 15pF$ (Figures 13, 14)	●		60	160	ns
$t_{ENH, L}$	Receiver Enable to Output Active	$C_L = 100pF$ (Figures 6, 7, 15)	●		30	100	ns
$t_{H, Ldis}$	Receiver Output Active to Disable	$C_L = 15pF$ (Figures 6, 7, 15)	●		30	100	ns

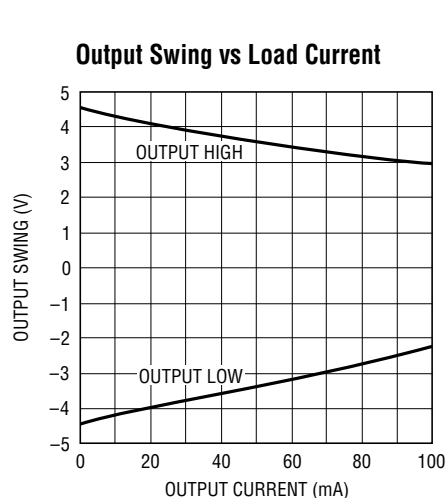
The ● denotes specifications which apply over the full operating temperature range.

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

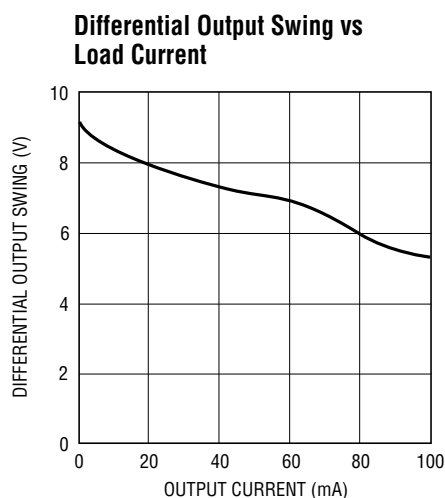
Note 2: All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to ground unless otherwise specified.

Note 3: All typicals are given at $V_S = \pm 5V$, $T_A = 25^\circ C$.

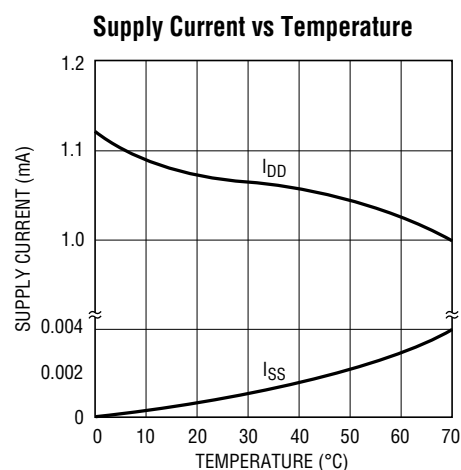
TYPICAL PERFORMANCE CHARACTERISTICS



LTC1320 • G01



LTC1320 • G02



LTC1320 • G03

PIN FUNCTIONS

TXD (Pin 1): RS422 Differential Driver Input (TTL Compatible).

TXI (Pin 2): RS562 Single-Ended Driver Input (TTL compatible).

TXDEN (Pin 3): RS422 Differential Driver Output Enable (TTL Compatible). A high level on this pin forces the

RS422 driver into three-state; a low level enables the driver. This input does not affect the RS562 single-ended driver.

SD (Pin 4): Shutdown Input (TTL Compatible). When this pin is high, the chip is shut down: all driver outputs three-state and the supply current drops to 30μA. A low on this pin allows normal operation.

PIN FUNCTIONS

RXEN (Pin 5): Receiver Enable (TTL Compatible). A high level on this pin disables the receivers and three-states the logic outputs; a low level allows normal operation. To prevent erratic behavior at the receiver outputs during shutdown, RXEN should be pulled high along with SD.

RXO (Pin 6): Inverting RS562 Single-Ended Receiver Output.

RXO (Pin 7): Noninverting RS562 Single-Ended Receiver Output.

RXDO (Pin 8): RS422 Differential Receiver Output.

GND (Pin 9): Ground Pin.

RXD⁺ (Pin 10): RS422 Differential Receiver Noninverting Input. When this pin is $\geq 200\text{mV}$ above RXD⁻, RXDO will be high; when this pin is $\geq 200\text{mV}$ below RXD⁻, RXDO will be low.

RXD⁻ (Pin 11): RS422 Differential Receiver Inverting Input.

RXI (Pin 12): Noninverting RS562 Receiver Input. This input controls the RXO output; it has no effect on the RXO output.

RXI (Pin 13): Inverting RS562 Receiver Input. This input controls the RXO output; it has no effect on the RXO output.

V_{SS} (Pin 14): Negative Supply. $-4.75\text{V} \geq V_{SS} \geq -5.25\text{V}$. The voltage on this pin must never exceed ground on power up or power-down.

TXO (Pin 15): RS562 Single-Ended Driver Output.

TXD⁺ (Pin 16): RS422 Differential Driver Noninverting Output.

TXD⁻ (Pin 17): RS422 Differential Driver Inverting Output.

V_{DD} (Pin 18): Positive Supply. $4.75\text{V} \leq V_{DD} \leq 5.25\text{V}$.

TEST CIRCUITS

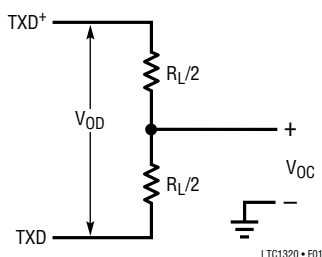


Figure 1

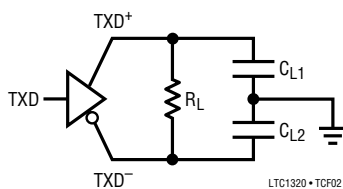


Figure 2

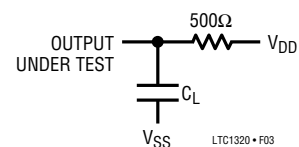


Figure 3

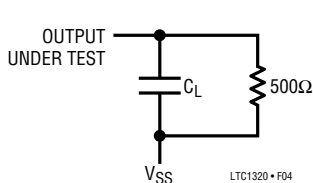


Figure 4

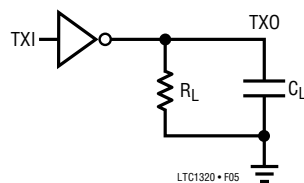


Figure 5

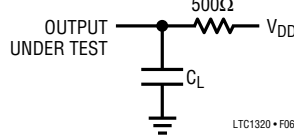


Figure 6

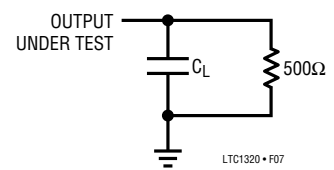


Figure 7

SWITCHING WAVEFORMS

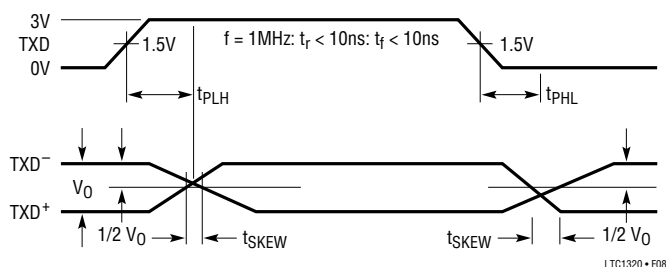


Figure 8

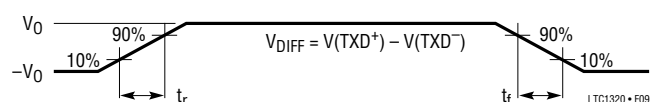


Figure 9

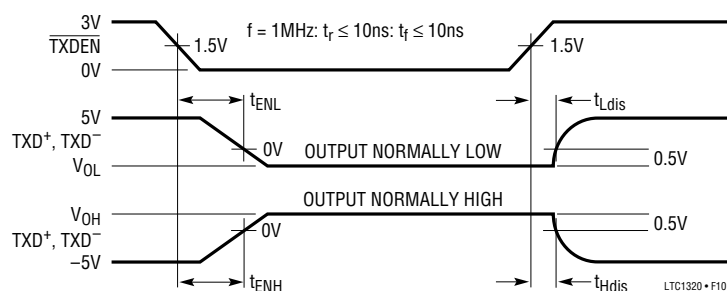


Figure 10

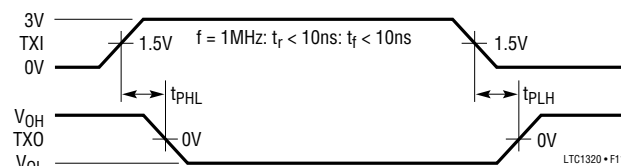


Figure 11

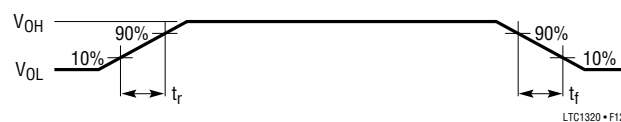


Figure 12

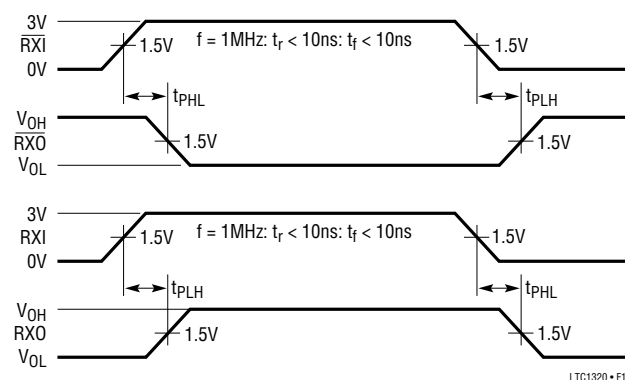


Figure 13

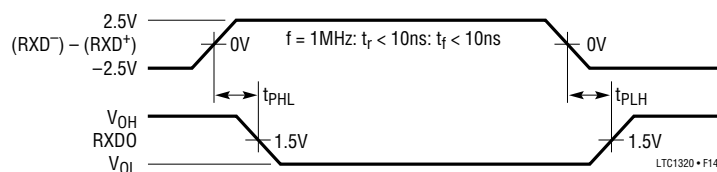


Figure 14

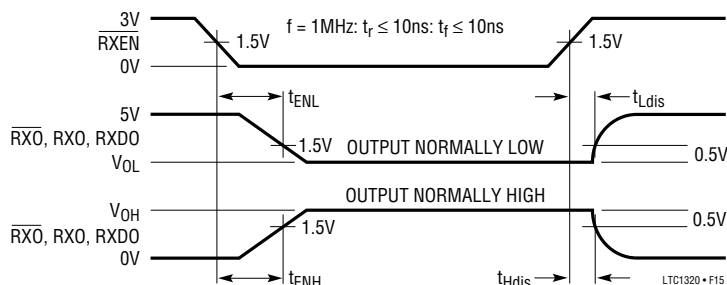


Figure 15

APPLICATIONS INFORMATION

Thermal Shutdown Protection

The LTC1320 includes a thermal shutdown circuit which protects the part against prolonged shorts at the driver outputs. If any driver output is shorted to another output or to the power supply, the current will be initially limited to 450mA max. The die temperature will rise to about 150°C, at which point the thermal shutdown circuit turns off the driver outputs. When the die cools to about 130°C, the outputs re-enable. If the shorted condition still exists, the part will heat again and the cycle will repeat. When the short is removed, the part will return to normal operation. This oscillation occurs at about 10Hz and prevents the part from being damaged by excessive power dissipation.

Power Shutdown

The power shutdown feature of the LTC1320 is designed primarily for battery-powered systems. When SD (pin 4) is forced high, the part enters shutdown mode. In shut-

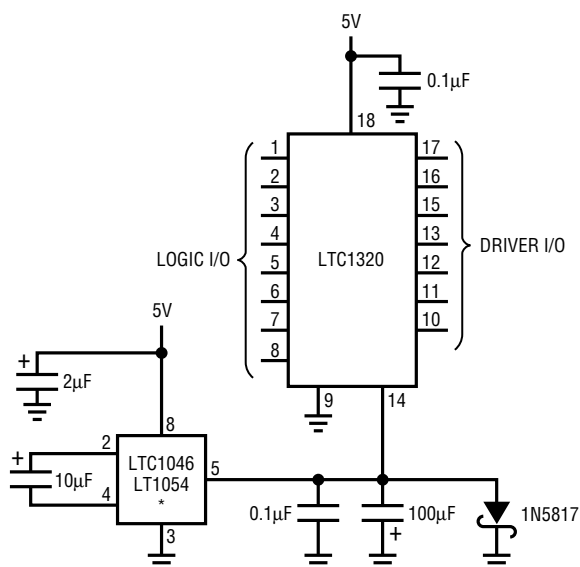
down, the supply current drops from 1.2mA to 30µA typ. The driver outputs are three-stated and the power to the receivers is removed. The receiver outputs are not automatically three-stated in shutdown, and can toggle erroneously due to feedthrough from the inputs. This can be prevented by pulling $\overline{\text{RXEN}}$ high along with SD; this will three-state the receiver outputs and prevent the generation of spurious data.

Supply Bypassing

The LTC1320 requires that both V_{DD} and V_{SS} are well bypassed; data errors can result from inadequate bypassing. Bypass capacitor values of 0.1µF to 1µF from V_{DD} to ground and from V_{SS} to ground are adequate. Lead lengths and trace lengths between the capacitors and the chip should be short to minimize lead inductance.

TYPICAL APPLICATIONS

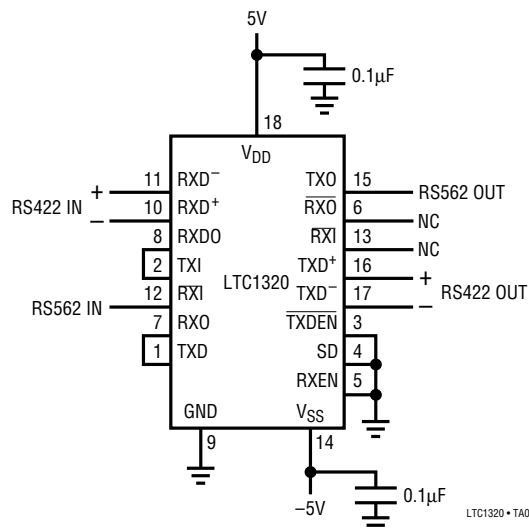
Single 5V Supply



* LTC1046 GIVES 300µA QUIESCENT CURRENT WHEN LTC1320 IS SHUT DOWN
LT1054 PROVIDES HIGHER OUTPUT DRIVE

LTC1320 • TA03

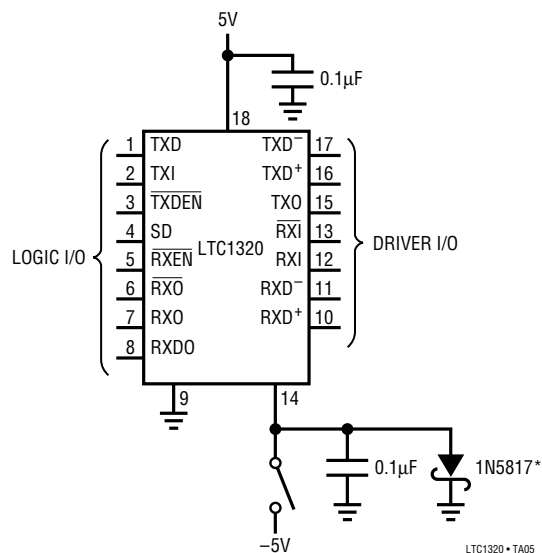
RS422 to RS562/RS562 to RS422 Converter



LTC1320 • TA04

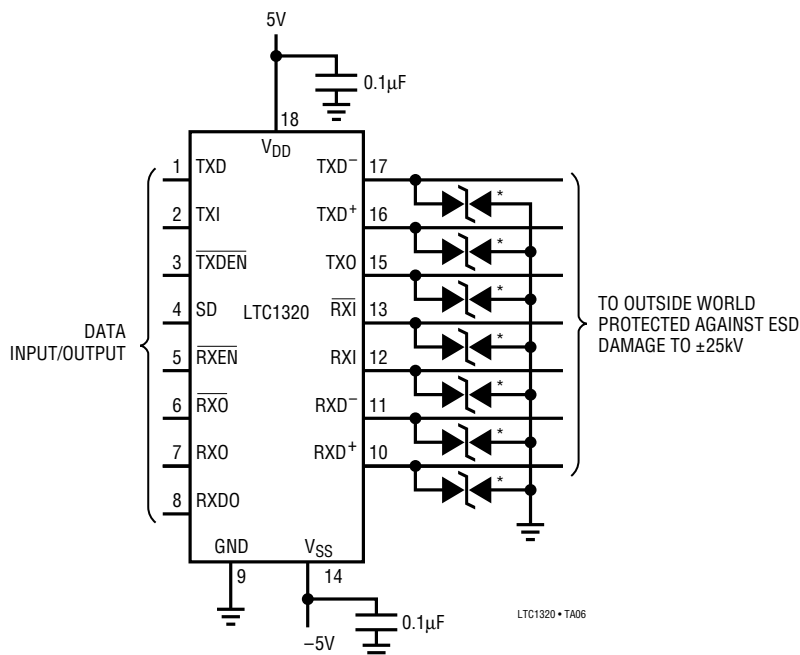
TYPICAL APPLICATIONS

Switched Negative Supply



*SCHOTTKY DIODE PREVENTS V_{SS} FROM EXCEEDING GND ON POWER-UP OR POWER-DOWN

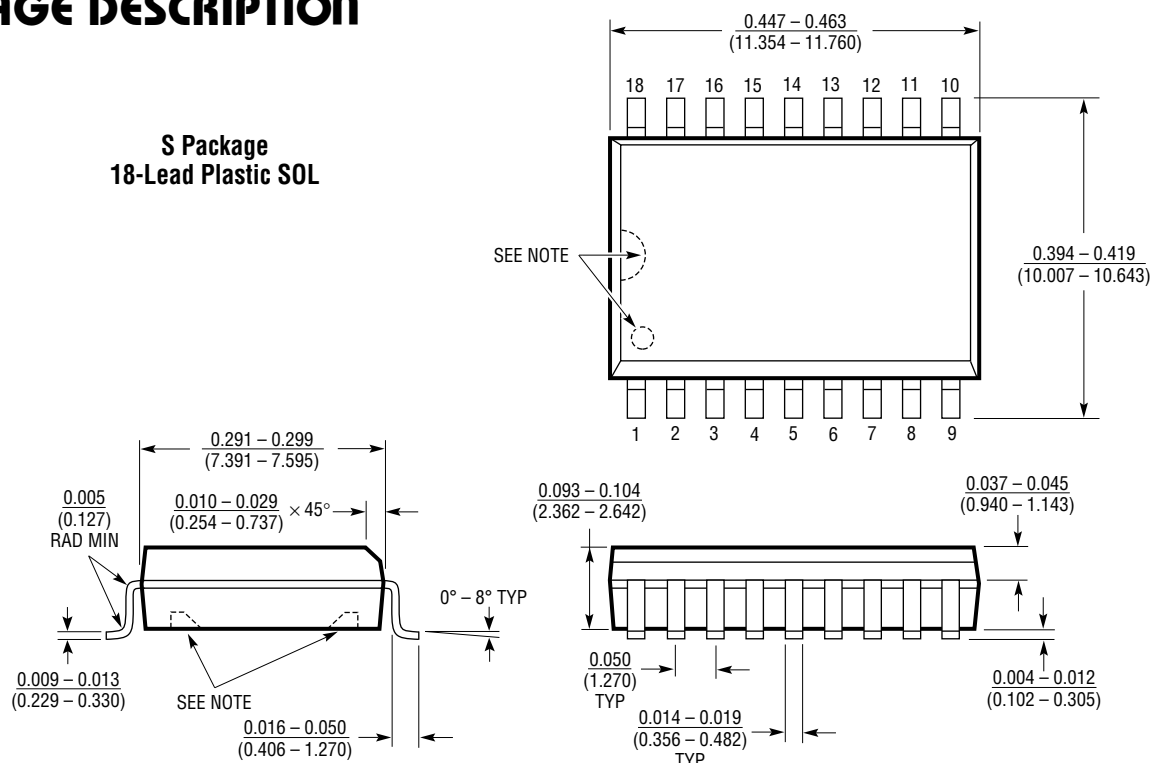
≥25k ESD Protection



*GENERAL SEMICONDUCTOR ICTE-22C OR EQUIVALENT

PACKAGE DESCRIPTION

S Package
18-Lead Plastic SOL



NOTE:
PIN 1 IDENT, NOTCH ON TOP AND CAVITIES ON THE BOTTOM OF PACKAGES ARE THE MANUFACTURING OPTIONS.
THE PART MAY BE SUPPLIED WITH OR WITHOUT ANY OF THE OPTIONS.

SOL18 0392

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